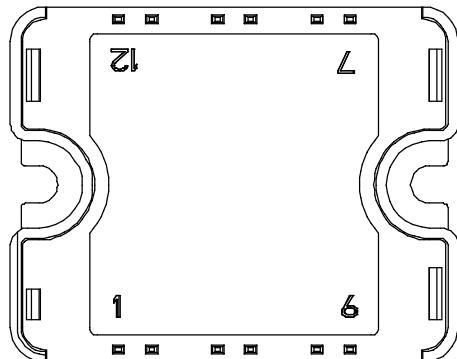
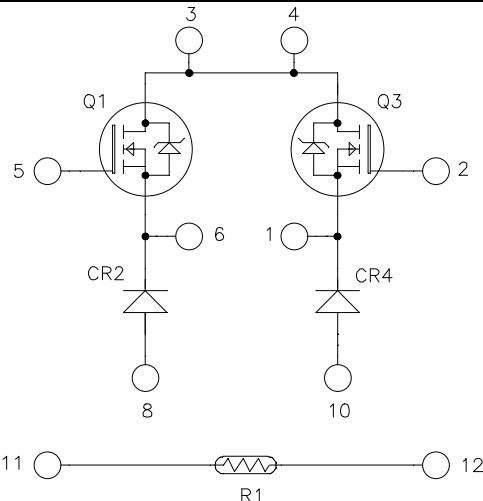


**Dual buck chopper
Super Junction MOSFET
SiC chopper diode**



Pins 3/4 must be shorted together

V_{DSS} = 600V

R_{DSon} = 70mΩ max @ T_j = 25°C

I_D = 39A @ T_c = 25°C

Application

- AC and DC motor control
- Switched Mode Power Supplies

Features



- Ultra low R_{DSon}
- Low Miller capacitance
- Ultra low gate charge
- Avalanche energy rated
- Very rugged
- **SiC Schottky Diode**
 - Zero reverse recovery
 - Zero forward recovery
 - Temperature Independent switching behavior
 - Positive temperature coefficient on VF
- Very low stray inductance
 - Symmetrical design
- Internal thermistor for temperature monitoring
- High level of integration

Benefits

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Solderable terminals both for power and signal for easy PCB mounting
- Low profile
- RoHS Compliant

Absolute maximum ratings

Symbol	Parameter	Max ratings	Unit
V _{DSS}	Drain - Source Breakdown Voltage	600	V
I _D	Continuous Drain Current	T _c = 25°C	A
		T _c = 80°C	
I _{DM}	Pulsed Drain current	160	
V _{GS}	Gate - Source Voltage	±20	V
R _{DSon}	Drain - Source ON Resistance	70	mΩ
P _D	Maximum Power Dissipation	T _c = 25°C	W
I _{AR}	Avalanche current (repetitive and non repetitive)	20	A
E _{AR}	Repetitive Avalanche Energy	1	mJ
E _{AS}	Single Pulse Avalanche Energy	1800	

 **CAUTION:** These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com

All ratings @ $T_j = 25^\circ\text{C}$ unless otherwise specified

Electrical Characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
I_{DSS}	Zero Gate Voltage Drain Current	$V_{GS} = 0\text{V}$, $V_{DS} = 600\text{V}$	$T_j = 25^\circ\text{C}$			25	μA
		$V_{GS} = 0\text{V}$, $V_{DS} = 600\text{V}$	$T_j = 125^\circ\text{C}$			250	
$R_{DS(on)}$	Drain – Source on Resistance	$V_{GS} = 10\text{V}$, $I_D = 39\text{A}$				70	$\text{m}\Omega$
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 2.7\text{mA}$		2.1	3	3.9	V
I_{GSS}	Gate – Source Leakage Current	$V_{GS} = \pm 20\text{ V}$, $V_{DS} = 0\text{V}$				± 100	nA

Dynamic Characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
C_{iss}	Input Capacitance	$V_{GS} = 0\text{V}$ $V_{DS} = 25\text{V}$ $f = 1\text{MHz}$			7		nF
C_{oss}	Output Capacitance				2.56		
C_{rss}	Reverse Transfer Capacitance				0.21		
Q_g	Total gate Charge	$V_{GS} = 10\text{V}$ $V_{Bus} = 300\text{V}$ $I_D = 39\text{A}$			259		nC
Q_{gs}	Gate – Source Charge				29		
Q_{gd}	Gate – Drain Charge				111		
$T_{d(on)}$	Turn-on Delay Time	Inductive Switching @ 125°C $V_{GS} = 15\text{V}$ $V_{Bus} = 400\text{V}$ $I_D = 39\text{A}$ $R_G = 5\Omega$			21		ns
T_r	Rise Time				30		
$T_{d(off)}$	Turn-off Delay Time				283		
T_f	Fall Time				84		
E_{on}	Turn-on Switching Energy	Inductive switching @ 25°C $V_{GS} = 15\text{V}$, $V_{Bus} = 400\text{V}$ $I_D = 39\text{A}$, $R_G = 5\Omega$			402		μJ
E_{off}	Turn-off Switching Energy				980		
E_{on}	Turn-on Switching Energy	Inductive switching @ 125°C $V_{GS} = 15\text{V}$, $V_{Bus} = 400\text{V}$ $I_D = 39\text{A}$, $R_G = 5\Omega$			657		μJ
E_{off}	Turn-off Switching Energy				1206		

Chopper SiC diode ratings and characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
V_{RRM}	Maximum Peak Repetitive Reverse Voltage			600			V
I_{RM}	Maximum Reverse Leakage Current	$V_R = 600\text{V}$	$T_j = 25^\circ\text{C}$		100	400	μA
			$T_j = 175^\circ\text{C}$		200	2000	
I_F	DC Forward Current		$T_c = 100^\circ\text{C}$		20		A
V_F	Diode Forward Voltage	$I_F = 20\text{A}$	$T_j = 25^\circ\text{C}$		1.6	1.8	V
			$T_j = 175^\circ\text{C}$		2	2.4	
Q_C	Total Capacitive Charge	$I_F = 20\text{A}$, $V_R = 300\text{V}$ $di/dt = 1800\text{A}/\mu\text{s}$			28		nC
C	Total Capacitance	$f = 1\text{MHz}$, $V_R = 200\text{V}$			130		pF
			$f = 1\text{MHz}$, $V_R = 400\text{V}$		100		

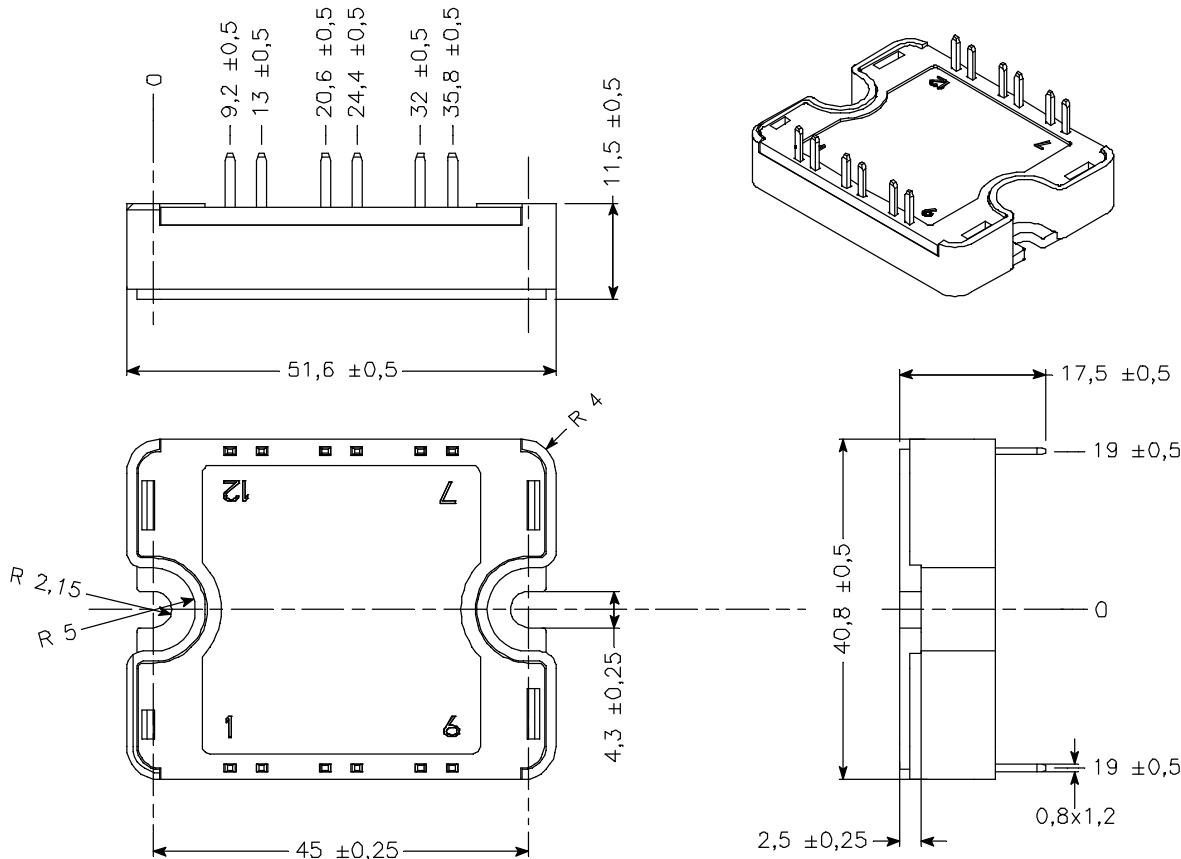
Thermal and package characteristics

Symbol	Characteristic		Min	Typ	Max	Unit
R_{thJC}	Junction to Case Thermal Resistance	CoolMOS			0.5	°C/W
		SiC Diode			1.5	
V_{ISOL}	RMS Isolation Voltage, any terminal to case t = 1 min, $I_{isol} < 1mA$, 50/60Hz	4000				V
T_J	Operating junction temperature range	-40		150		
T_{STG}	Storage Temperature Range	-40		125		°C
T_C	Operating Case Temperature	-40		100		
Torque	Mounting torque	To heatsink	M4	2.5	4.7	N.m
Wt	Package Weight				80	g

Temperature sensor NTC (see application note APT0406 on www.microsemi.com for more information).

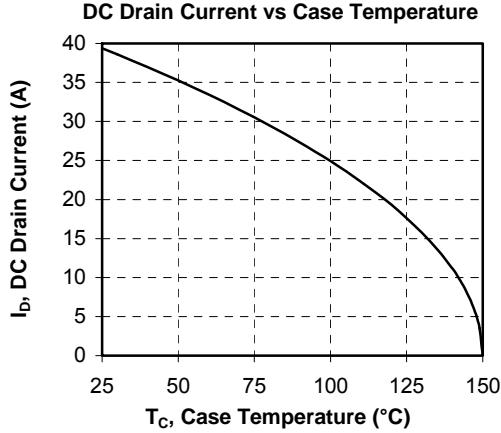
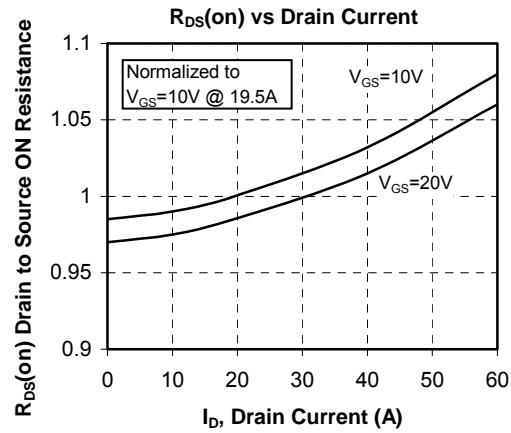
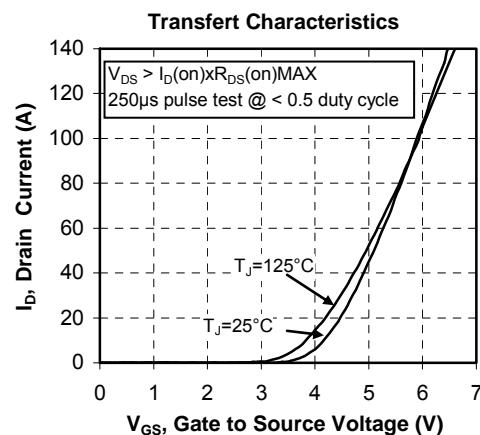
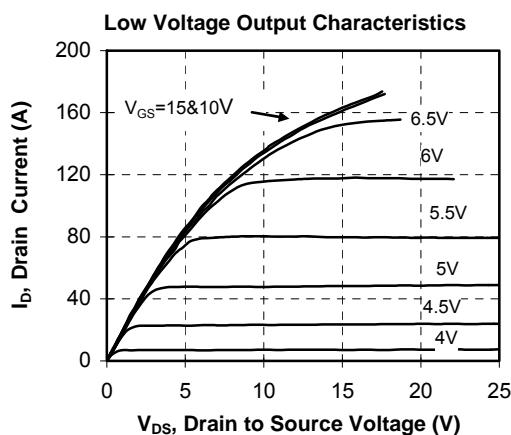
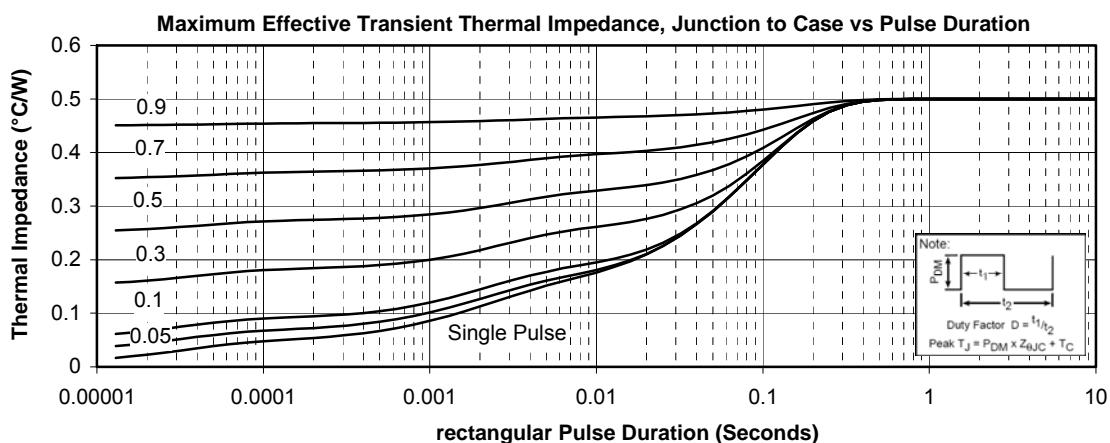
Symbol	Characteristic		Min	Typ	Max	Unit
R_{25}	Resistance @ 25°C			50		kΩ
$\Delta R_{25}/R_{25}$				5		%
$B_{25/85}$	$T_{25} = 298.15 \text{ K}$			3952		K
$\Delta B/B$		$T_C=100^\circ\text{C}$		4		%

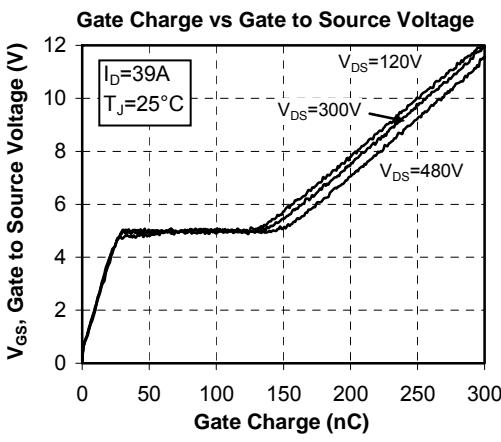
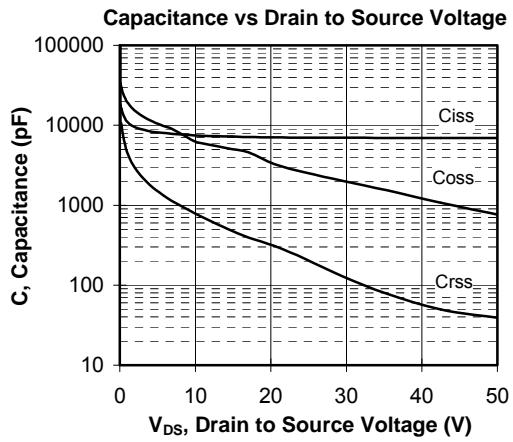
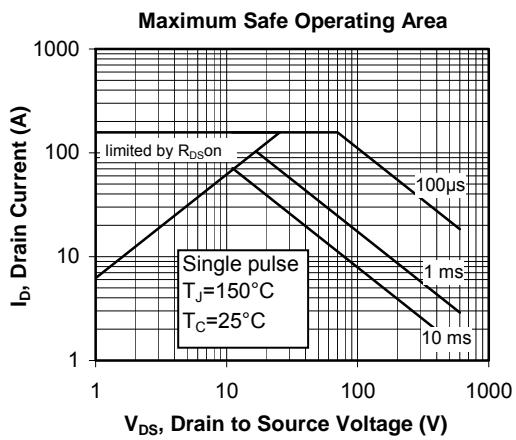
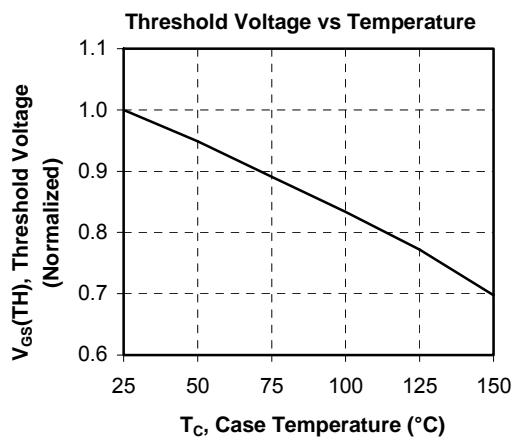
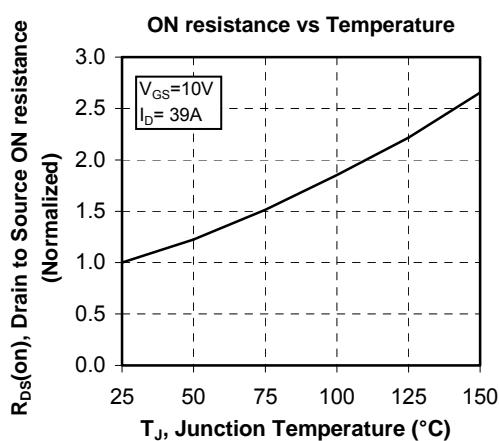
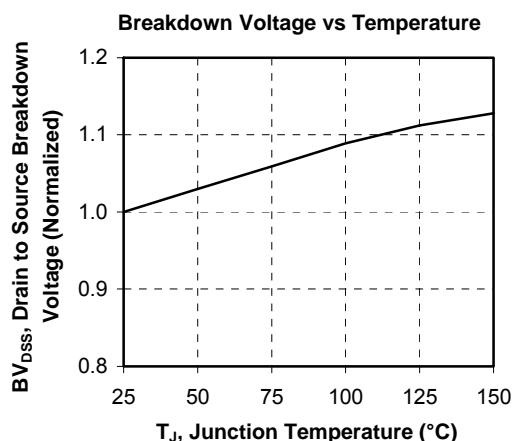
$$R_T = \frac{R_{25}}{\exp\left[B_{25/85}\left(\frac{1}{T_{25}} - \frac{1}{T}\right)\right]} \quad \begin{array}{l} T: \text{ Thermistor temperature} \\ R_T: \text{ Thermistor value at } T \end{array}$$

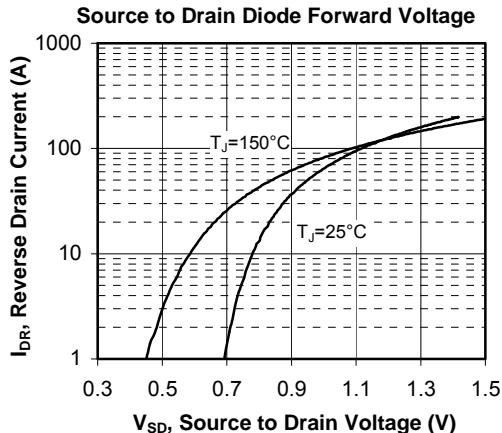
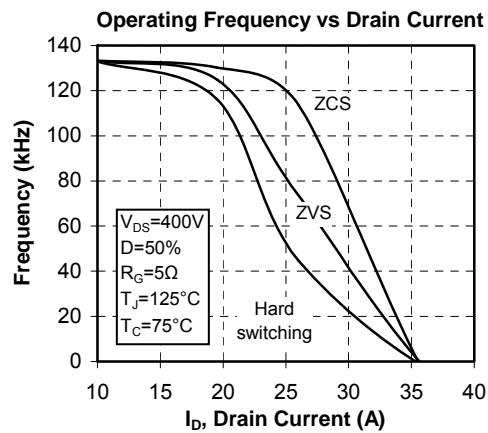
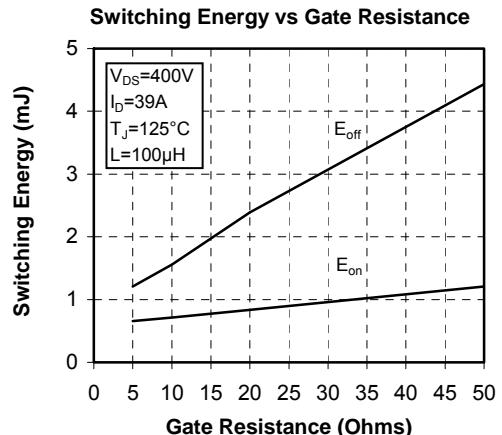
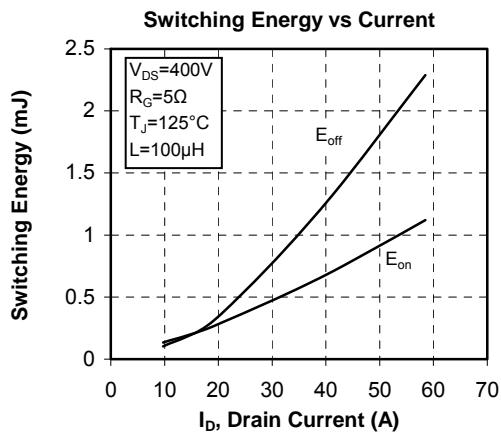
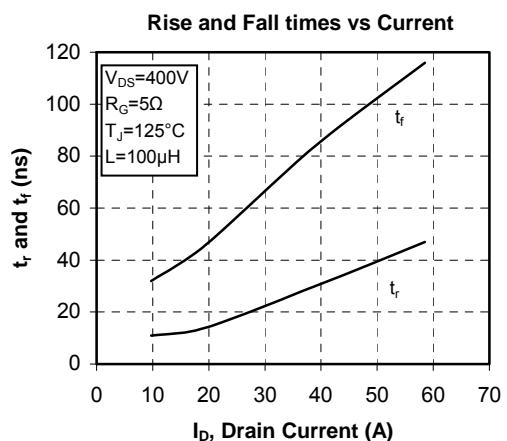
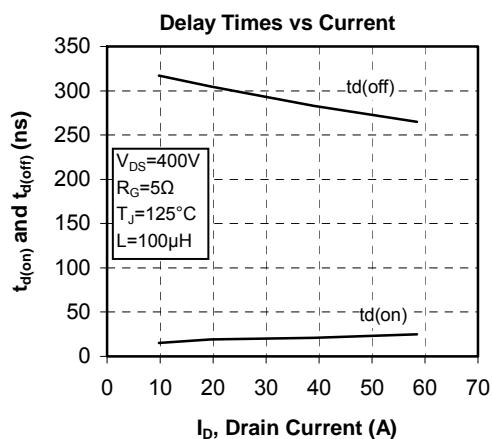
SP1 Package outline (dimensions in mm)


See application note 1904 - Mounting Instructions for SP1 Power Modules on www.microsemi.com

Typical Performance Curve

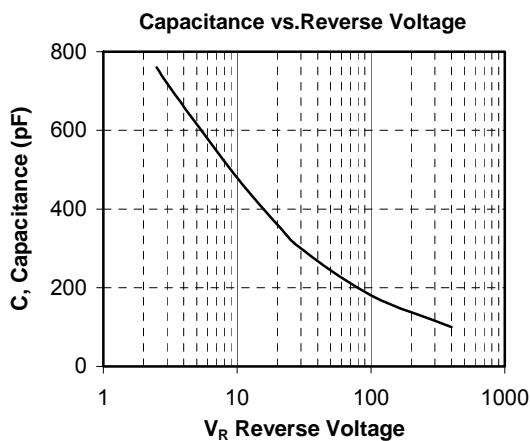
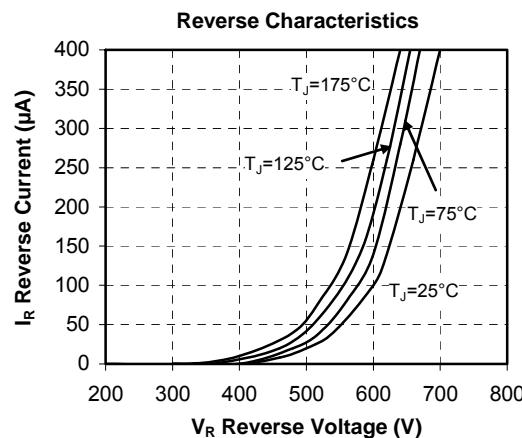
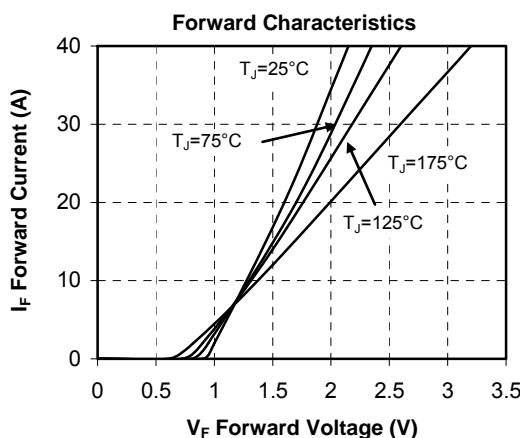
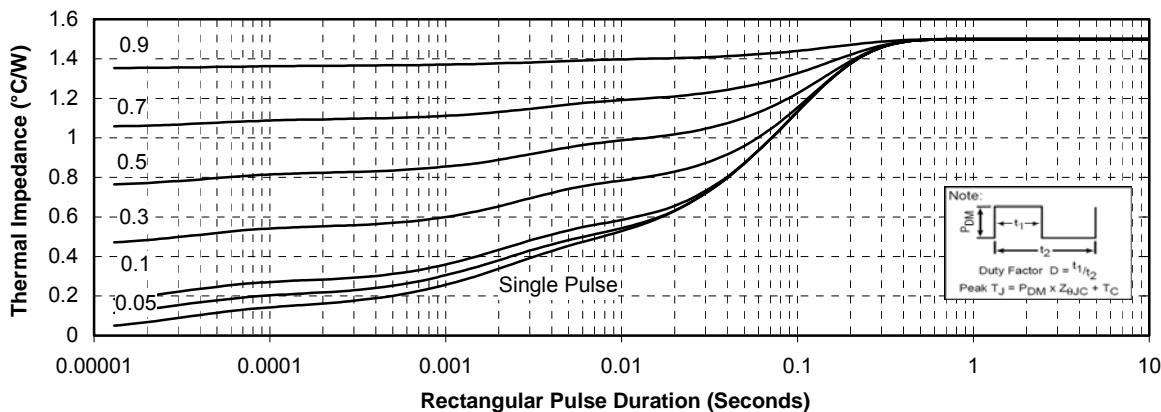






SiC Typical Performance Curve

Maximum Effective Transient Thermal Impedance, Junction to Case vs Pulse Duration



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